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December 2009

FSUSB43 — Low-Power, Two-Port, High-Speed, USB2.0 (480Mbps) Switch

Features

- Over-Voltage Tolerance (OVT) on all USB Ports up to 5.25V without External Components
- Low On Capacitance: 3.7pF Typical
 Low On Resistance: 3.9Ω Typical
- Low Power Consumption: 1µA Maximum
 - 20μA Maximum I_{CCT} over an Expanded Voltage Range (V_{IN}=1.8V, V_{CC}=4.3V)
- Wide -3db Bandwidth: > 720MHz
- Packaged in 10-Lead MicroPak™ (1.6 x 2.1mm)
- 8kV ESD Rating, >16kV Power/GND ESD Rating
- Power-Off Protection on All Ports when V_{CC}=0V
 - D+/D- Pins Tolerate up to 5.25V

Applications

- Cell phone, PDA, Digital Camera, and Notebook
- LCD Monitor, TV, and Set-Top Box

IMPORTANT NOTE:

For additional performance information, please contact analogswitch@fairchildsemi.com.

Description

The FSUSB43 is a bi-directional, low-power, two-port, high-speed, USB2.0 switch. Configured as a double-pole, double-throw (DPDT) switch, it is optimized for switching between two high-speed (480Mbps) sources or a high-speed and full-speed (12Mbps) source.

The FSUSB43 is compatible with the requirements of USB2.0 and features an extremely low on capacitance (C_{ON}) of 3.7pF. The wide bandwidth of this device (720 MHz) exceeds the bandwidth needed to pass the third harmonic, resulting in signals with minimum edge and phase distortion. Superior channel-to-channel crosstalk also minimizes interference.

The FSUSB43 contains special circuitry on the switch I/O pins for applications where the V_{CC} supply is powered-off (V_{CC} =0), which allows the device to withstand an over-voltage condition. This minimizes current consumption even when the control voltage applied to the SEL pin is lower than the supply voltage (V_{CC}). This feature is especially valuable to mobile applications, such as cell phones, allowing for direct interface with the general-purpose I/Os of the baseband processor. Other applications include switching and connector sharing in portable cell phones, PDAs, digital cameras, printers, and notebook computers.

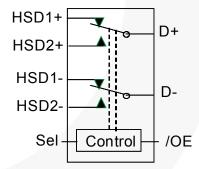


Figure 1. Analog Symbol

Ordering Information

Part Number	Top Mark	Operating Temperature Range	Eco Status	Package
FSUSB43L10X	JH	-40 to +85°C	l (∹reen	10-Lead MicroPak™ 1.6 x 2.1mm, JEDEC MO-255B

MicroPak™ is a trademark of Fairchild Semiconductor Corporation.

For Fairchild's definition of Eco Status, please visit: http://www.fairchildsemi.com/company/green/rohs_green.html.

Pin Configuration

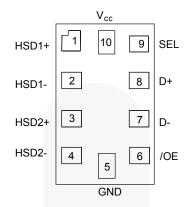


Figure 2. Pin Assignment (Top Through View)

Pin Definitions

Pin #	Name	Description
1	HSD1+	Multiplexed Source Inputs
2	HSD1-	Multiplexed Source Inputs
3	HSD2+	Multiplexed Source Inputs
4	HSD2-	Multiplexed Source Inputs
5	GND	Ground
6	/OE	Switch Enable
7	D-	USB Data Bus
8	D+	USB Data Bus
9	SEL	Switch Select
10	V _{CC}	Supply Voltage

Truth Table

SEL	/OE	Function
X	HIGH	Disconnect
LOW	LOW	D+, D-=HSD1+, HSD1-
HIGH	LOW	D+, D-=HSD2+, HSD2-

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Min.	Max.	Unit	
Vcc	Supply Voltage	-0.5	+5.5	V	
V _{CNTRL}	DC Input Voltage (Sel, /OE) ⁽¹⁾		-0.5	V _{CC}	V
V _{SW}	ALL PINS for V _{CC} 0 to 5.5V	-0.5	5.5	V	
I _{IK}	DC Input Diode Current	-50		mA	
lout	DC Output Current		100	mA	
T _{STG}	Storage Temperature		-65	+150	°C
		All Pins		8	
ESD	Human Body Model: JEDEC JESD22-A114	I/O to GND		9	147
ESD		Power to GND		16	kV
	Charged Device Model: JEDEC JESD22-C10		2		

Note:

1. The input and output negative ratings may be exceeded if the input and output diode current ratings are observed.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Min.	Max.	Unit
V_{CC}	Supply Voltage	3.0	4.3	V
V _{CNTRL}	Control Input Voltage ⁽²⁾ (Sel, /OE)	0	V _{CC}	V
V_{SW}	Switch I/O Voltage	-0.5	4.5	V
T _A	Operating Temperature	-40	+85	°C

Note:

2. The control input must be held HIGH or LOW; it must not float.

DC Electrical Characteristics

All typical values are at 25°C unless otherwise specified.

Comple at	Parameter	Conditions	V 00	T _A =- 40°C to +85°C			Heite
Symbol			V _{cc} (V)	Min.	Тур.	Max.	Units
V _{IK}	Clamp Diode Voltage	I _{IN} =-18mA	3.0			-1.2	V
\/	Input Voltage Lligh		3.0 to 3.6	1.3			V
V _{IH}	Input Voltage High		4.3	1.7			V
	Input Voltage Love		3.0 to 3.6			0.5	V
VIL	Input Voltage Low		4.3			0.7	V
I _{IN}	Control Input Leakage	V _{SW} =0 to V _{CC}	4.3	-1.0		1.0	μΑ
I _{OZ}	Off State Leakage	0 ≤ Dn, HSD1n, HSD2n ≤ 3.6V	4.3	-2.0		2.0	μA
I _{OFF}	Power-Off Leakage Current (All I/O Ports)	V _{SW} =0V to 4.3V, V _{CC} =0V Figure 4	0	-2		2	μA
Ron	HS Switch On Resistance ⁽³⁾	V _{SW} =0.4V, I _{ON} =-8mA Figure 3	3.0		3.9	6.5	Ω
ΔR_{ON}	HS Delta R _{ON} ⁽⁴⁾	V_{SW} =0.4V, I_{ON} =-8mA	3.0		0.65		Ω
IQ	Quiescent Supply Current	V _{CNTRL} =0 or V _{CC} , I _{OUT} =0	4.3			1.0	μA
	Increase in IQ Current per	V _{CNTRL} =2.6V, V _{CC} =4.3V	4.3	\		10.0	μA
Ісст	Control Voltage and V _{CC}	V _{CNTRL} =1.8V, V _{CC} =4.3V	4.3			20.0	μA

- Measured by the voltage drop between HSDn and Dn pins at the indicated current through the switch. On resistance is determined by the lower of the voltage on the two (HSDn or Dn ports). Guaranteed by characterization.

AC Electrical Characteristics

All typical values are for V_{CC}=3.3V at 25°C unless otherwise specified.

Cymbol	Parameter	Conditions	V 00	T _A =- 4	Units		
Symbol			V _{cc} (V)	Min.	Тур.	Max.	Ullits
t _{ON}	Turn-On Time SEL, /OE to Output	R_L =50 Ω , C_L =5pF, V_{SW} =0.8V Figure 5, Figure 6	3.0 to 3.6		13	30	ns
t _{OFF}	Turn-Off Time SEL, /OE to Output	R_L =50 Ω , C_L =5pF, V_{SW} =0.8V Figure 5, Figure 6	3.0 to 3.6		12	25	ns
t _{PD}	Propagation Delay ⁽⁵⁾	R_L =50 Ω , C_L =5 pF Figure 5, Figure 7	3.3		0.25		ns
t _{BBM}	Break-Before-Make Time ⁽⁵⁾	R_L =50 Ω , C_L =5pF V_{SW1} = V_{SW2} =0.8V Figure 9	3.0 to 3.6	2.0		6.5	ns
OIRR	Off Isolation ⁽⁵⁾	R_L =50 Ω , f=240MHz Figure 11	3.0 to 3.6		-30		dB
Xtalk	Non-Adjacent Channel Crosstalk ⁽⁵⁾	R _L =50Ω, f=240MHz Figure 12	3.0 to 3.6		-45		dB
BW	3dh Bandwidth ⁽⁵⁾	R_L =50 Ω , C_L =0pF Figure 10	3.0 to 3.6		720		MHz
DVV	-3db Bandwidth ⁽⁵⁾	R_L =50 Ω , C_L =5pF Figure 10	3.0 (0 3.6		550		MHz

Note:

USB High-Speed-Related AC Electrical Characteristics

Cumbal	Devemeter	Conditions	V _{cc} (V)	T _A =- 40°C to +85°C			Heite
Symbol	Parameter	Conditions		Min.	Тур.	Max.	Units
t _{SK(P)}	Skew of Opposite Transitions of the Same Output ⁽⁶⁾	$R_L=50\Omega$, $C_L=5pF$ Figure 8	3.0 to 3.6		20		ps
tJ	Total Jitter ⁽⁶⁾	R_L =50 Ω , C_L =5pf, t_r = t_r =500ps (10-90%) at 480Mbps, (PRBS= 2^{15} – 1)	3.0 to 3.6		200	7	ps

Note:

Capacitance

Cymahal	Parameter	Conditions	T _A =- 40°C to +85°C			Unite
Symbol		Conditions	Min.	Тур.	Max.	Units
C _{IN}	Control Pin Input Capacitance ⁽⁷⁾	V _{CC} =0V		1.5		
Con	D+/D- On Capacitance ⁽⁷⁾	V _{CC} =3.3V, /OE=0V, f=240MHz Figure 14		3.7		pF
C _{OFF}	D1n, D2n Off Capacitance ⁽⁷⁾	V _{CC} and /OE=3.3V Figure 13		2.0		

Note:

7. Guaranteed by characterization.

^{5.} Guaranteed by characterization.

^{6.} Guaranteed by characterization.

Test Diagrams

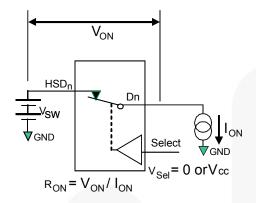
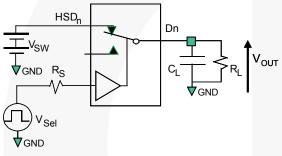
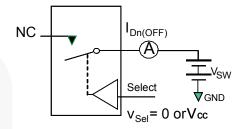


Figure 3. On Resistance



 R_L , R_S , and C_L are functions of the application environment (see AC Tables for specific values) C_L includes test fixture and stray capacitance.

Figure 5. AC Test Circuit Load



**Each switch port is tested separately

Figure 4. Off Leakage

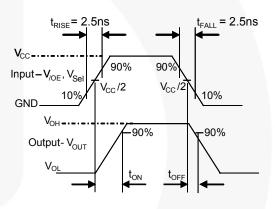


Figure 6. Turn-On / Turn-Off Waveforms

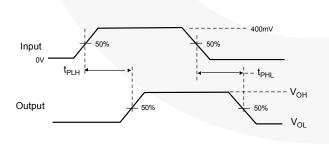


Figure 7. Propagation Delay (t_rt_f – 500ps)

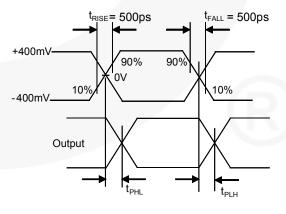


Figure 8. Intra-Pair Skew Test t_{SK(P)}

Figure 9. Break-Before-Make Interval Timing

C, includes test fixture and stray capacitance.

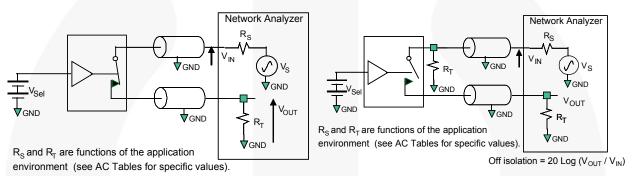


Figure 10. Bandwidth

Figure 11. Channel Off Isolation

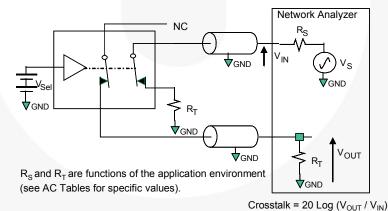


Figure 12. Non-Adjacent Channel-to-Channel Crosstalk

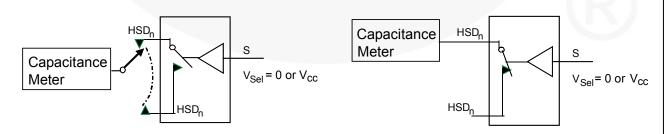
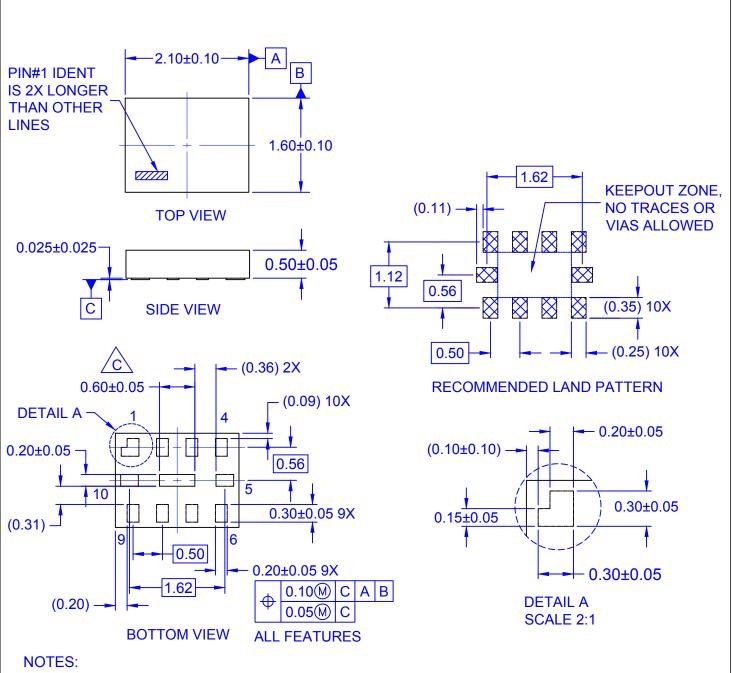


Figure 13. Channel Off Capacitance

Figure 14. Channel On Capacitance



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